

ThinWafer Packing Tool PT 300





Brand new:

- 400 wafers per hour (minimum)
- 65% less operator area needed
- Saves 72% on cleanroom space
- Outstanding “throughput/footprint ratio”

Specifications:

- Packing of 300 mm wafers
- > 50 µm
- Cleanroom class 10

Hard facts:

- **400 w/h throughput minimum**
The packing process runs at a minimum of 400 wafers per hour, because of the redesigned arrangement of the material boxes.
- **65% less operator area**
The PT 300 is operated and loaded only from the front.
- **Saves 72% on cleanroom space**
As the PT 300 is operated from the front this allows you to place only the front of the tool in the cleanroom saving 72% on cleanroom space.
Complete service area outside the cleanroom possible!
- **Outstanding “throughput/footprint ratio”**
On one square meter we process 133 wafers per hour.

